SDAS229A - APRIL 1982 - REVISED JANUARY 1995

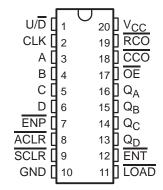
- 3-State Q Outputs Drive Bus Lines Directly
- Counter Operation Independent of 3-State Output
- Fully Synchronous Clear, Count, and Load
- Asynchronous Clear Is Also Provided
- Fully Cascadable
- Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

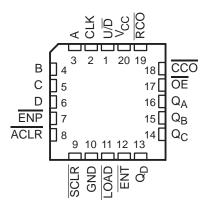
The SN74ALS568A decade counter and 'ALS569A binary counters are programmable, count up or down, and offer both synchronous and asynchronous clearing. All synchronous functions are executed on the positive-going edge of the clock (CLK) input.

The clear function is initiated by applying a low level to either asynchronous clear (\overline{ACLR}) or synchronous clear (\overline{SCLR}). Asynchronous (direct) clearing overrides all other functions of the device, while synchronous clearing overrides only the other synchronous functions. Data is loaded from the A, B, C, and D inputs by holding load (\overline{LOAD}) low during a positive-going clock transition. The counting function is enabled only when enable P (\overline{ENP}) and enable T (\overline{ENT}) are low and \overline{ACLR} , \overline{SCLR} , and \overline{LOAD} are high. The up/down (U/ \overline{D}) input controls the direction of the count. These counters count up when U/ \overline{D} is high and count down when U/ \overline{D} is low.

SN54ALS569A . . . J PACKAGE SN74ALS568A, SN74ALS569A . . . DW OR N PACKAGE (TOP VIEW)



SN54ALS569A . . . FK PACKAGE (TOP VIEW)



A high level at the output-enable (\overline{OE}) input forces the Q outputs into the high-impedance state, and a low level enables those outputs. Counting is independent of \overline{OE} . \overline{ENT} is fed forward to enable the ripple-carry output (\overline{RCO}) to produce a low-level pulse while the count is zero (all Q outputs low) when counting down or maximum (9 or 15) when counting up. The clocked carry output (\overline{CCO}) produces a low-level pulse for a duration equal to that of the low level of the clock when \overline{RCO} is low and the counter is enabled (both \overline{ENP} and \overline{ENT} are low); otherwise, \overline{CCO} is high. \overline{CCO} does not have the glitches commonly associated with a ripple-carry output. Cascading is normally accomplished by connecting \overline{RCO} or \overline{CCO} of the first counter to \overline{ENT} of the next counter. However, for very high-speed counting, \overline{RCO} should be used for cascading since \overline{CCO} does not become active until the clock returns to the low level.

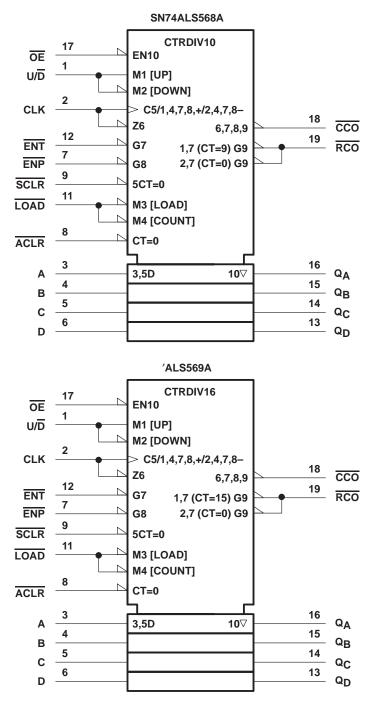
The SN54ALS569A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS568A and SN74ALS569A are characterized for operation from 0°C to 70°C.

SN54ALS569A, SN74ALS568A, SN74ALS569A SYNCHRONOUS 4-BIT UP/DOWN DECADE AND BINARY COUNTERS WITH 3-STATE OUTPUTS SDAS229A - APRIL 1982 - REVISED JANUARY 1995

FUNCTION TABLE

	•	ODED ATION						
OE	ACLR	SCLR	LOAD	ENT	ENP	U/D	CLK	OPERATION
Н	Х	Х	Х	Χ	Χ	Χ	Χ	Q outputs disabled
L	L	X	Χ	X	X	Χ	Χ	Asynchronous clear
L	Н	L	Χ	Χ	X	Χ	\uparrow	Synchronous clear
L	Н	Н	L	Χ	X	Χ	\uparrow	Load
L	Н	Н	Н	L	L	Н	\uparrow	Count up
L	Н	Н	Н	L	L	L	\uparrow	Count down
L	Н	Н	Н	Н	Χ	Χ	Χ	Inhibit count
L	Н	Н	Н	Χ	Н	Χ	Χ	Inhibit count

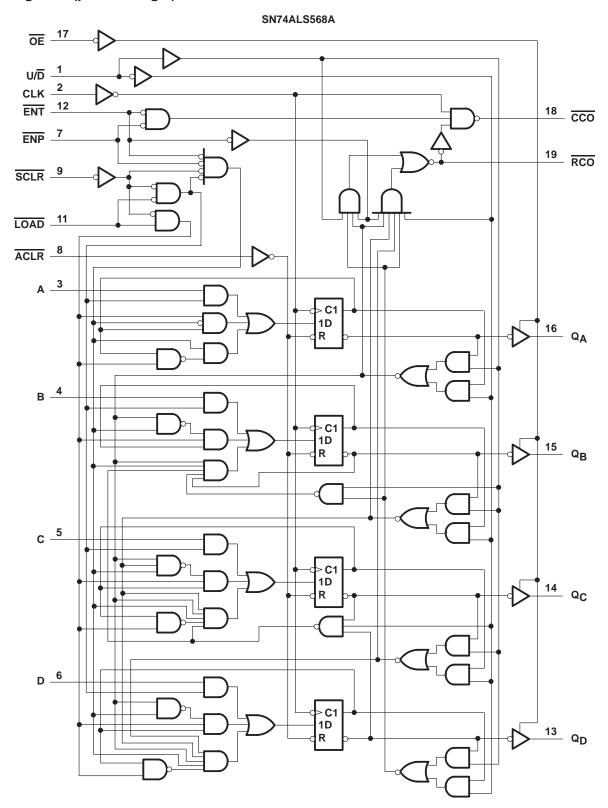
logic symbols†



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

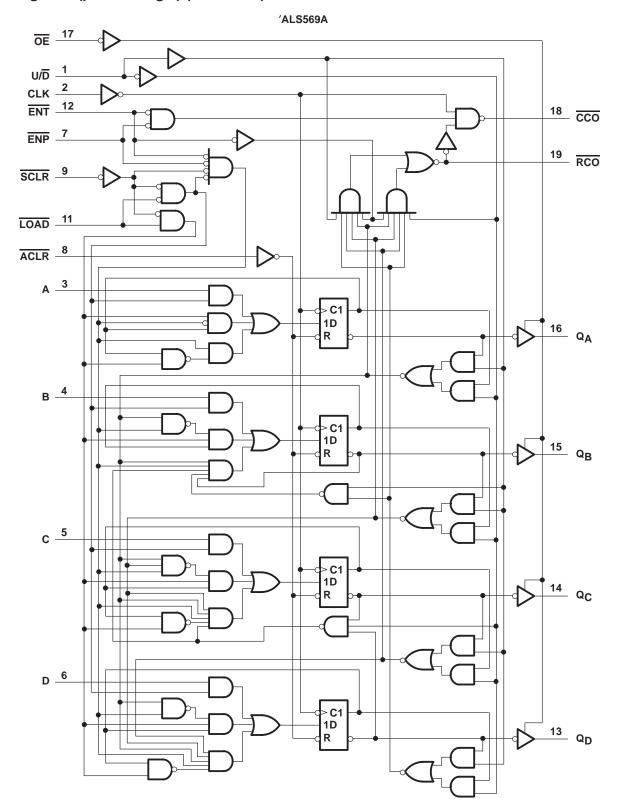
SDAS229A - APRIL 1982 - REVISED JANUARY 1995

logic diagrams (positive logic)



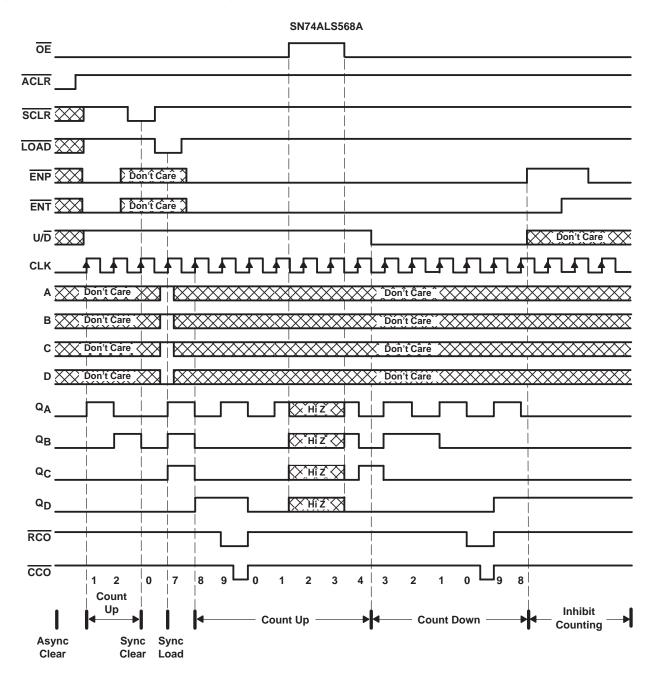


logic diagrams (positive logic) (continued)



SDAS229A - APRIL 1982 - REVISED JANUARY 1995

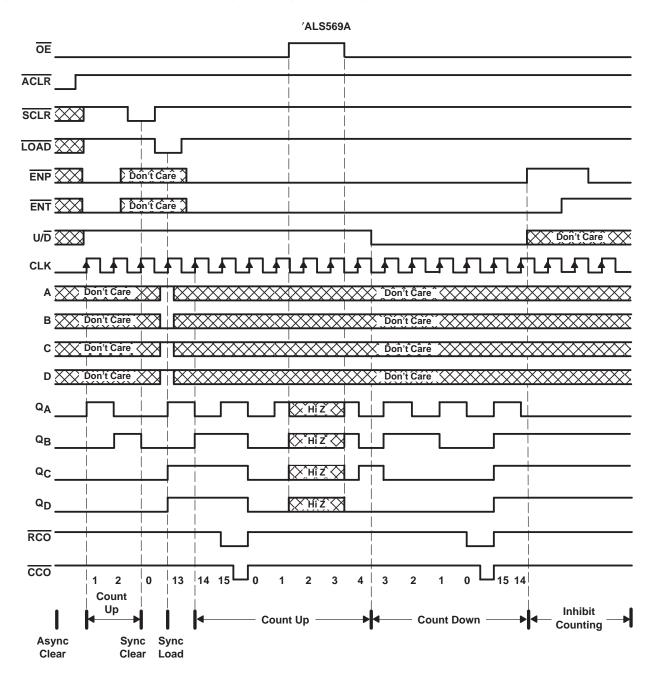
typical load, count, and inhibit sequences





SDAS229A - APRIL 1982 - REVISED JANUARY 1995

typical load, count, and inhibit sequences (continued)





SDAS229A - APRIL 1982 - REVISED JANUARY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Voltage applied to a disabled 3-state output	
Operating free-air temperature range, T _A : SN54ALS569A	55°C to 125°C
SN74ALS568A, SN74ALS569A	0°C to 70°C
Storage temperature range	-65°C to 150°C

recommended operating conditions

				SN54ALS569A		SN74ALS568A SN74ALS569A			UNIT	
				MIN	NOM	MAX	MIN	NOM	MAX	
Vсс	Supply voltage			4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage			2			2			V
\vee_{IL}	Low-level input voltage					0.7			0.8	V
	High-level output current	Q outputs				-1			-2.6	
ІОН	nigh-level output current	CCO and RCO				-0.4			-0.4	mA
loi	Low-level output current	Q outputs				12			24	mA
lOL	Low-level output current	CCO and RCO				4			8	IIIA
٤	Clock fraguency	SN74ALS568A					0		20	MHz
fclock	Clock frequency	'ALS569A		0		22	0		30	MHZ
	Pulse duration	ACLR or LOAD low	,	20			15			ns
		SN74ALS568A	CLK high				25			
t _W			CLK low				25			
		'ALS569A	CLK high	20			16.5			
		ALSSOSA	CLK low	23			16.5			
		Data at A, B, C, D		25			20			
		END ENE	High	35			30			
		ENP, ENT	Low	25			20			
			Low	20			15			
t _{su}	Setup time before CLK↑	SCLR	High (inactive)	35			30			ns
		LOAD	Low	20			15			
		LOAD	High (inactive)	35			30			
		U/D		35			30			
		ACLR inactive		10			10			
th	Hold time after CLK↑ for a	ny input		0			0			ns
TA	Operating free-air tempera	ture		-55		125	0		70	°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SDAS229A - APRIL 1982 - REVISED JANUARY 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SNS	SN54ALS569A			SN74ALS568A SN74ALS569A			
			MIN	TYP [†]	MAX	MIN	TYP [†]	MAX			
VIK		V _{CC} = 4.5 V,	$I_{I} = -18 \text{ mA}$			-1.5			-1.5	V	
	All outputs	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	2		V _{CC} -2	2			
VOH	Q outputs	V _{CC} = 4.5 V	$I_{OH} = -1 \text{ mA}$	2.4	3.3					V	
	Q outputs	vCC = 4.5 v	$I_{OH} = -2.6 \text{ mA}$				2.4	3.2			
	Q outputs	V _{CC} = 4.5 V	I _{OL} = 12 mA		0.25	0.4		0.25	0.4		
1/0	Q outputs	VCC = 4.5 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	V	
I VOL	VOL TOO	V _{CC} = 4.5 V	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	V	
	CCO and RCO		$I_{OL} = 8 \text{ mA}$					0.35	0.5		
lozh		$V_{CC} = 5.5 \text{ V},$	V _O = 2.7 V			20			20	μΑ	
lozL		V _{CC} = 5.5 V,	V _O = 0.4 V			-20			-20	μΑ	
lį		V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA	
lн		$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20			20	μΑ	
I _{IL}		$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.2			-0.2	mA	
. +	CCO and RCO	., 551		-15		-70	-15		-70		
10 [‡]	Q outputs	V _{CC} = 5.5 V,	$V_0 = 2.25 \text{ V}$	-20		-112	-30		-112	mA	
	-		Outputs high		16	26		16	26	mA	
ICC		V _{CC} = 5.5 V	Outputs low		20	32		20	32		
			Outputs disabled		20	32		20	32		

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

[‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

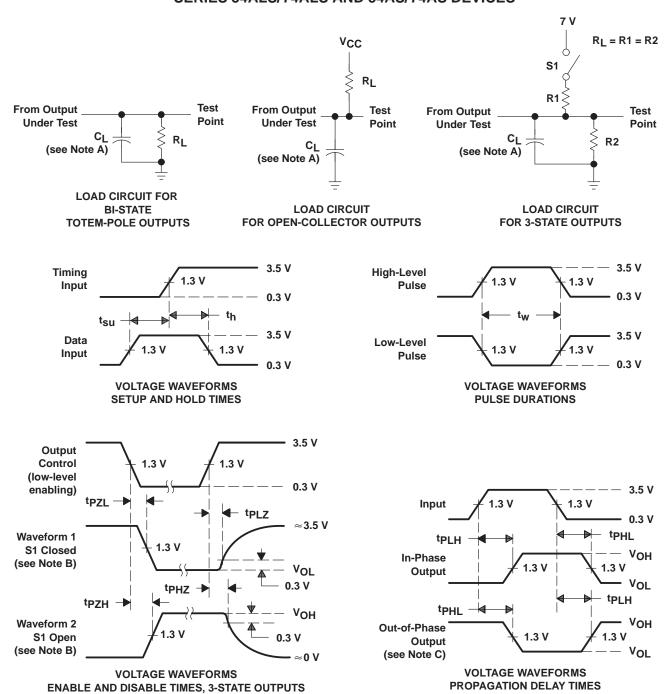
SDAS229A - APRIL 1982 - REVISED JANUARY 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω , R2 = 500 Ω , T_A = MIN to MAX †				UNIT
	((001101)	SN54AL	S569A	SN74ALS568A SN74ALS569A		
			MIN	MAX	MIN	MAX	
f _{max}	SN74AI	LS568A			20		MHz
max	'ALS	569A	22		30		IVII IZ
^t PLH	CLK	Any O	4	21	4	13	ns
^t PHL	OLK	Any Q	7	19	7	16	ris
^t PLH	CLK	RCO	12	37	12	28	ns
^t PHL	OEK	RCO	10	28	10	19	
^t PLH	CLK	cco	5	17	5	13	ns
^t PHL	CLK	CCO	6	30	6	25	
^t PLH	U/ D	RCO	9	31	9	23	ns
^t PHL	0/0	RCO	9	33	9	19	
^t PLH	ENT	RCO	6	21	6	15	ns
^t PHL	LIVI	ROO	4	20	4	13	
^t PLH	ENT	cco	5	18	5	13	ns
^t PHL	LIVI	000	9	32	9	23	
^t PLH	<u>ENP</u>	cco	4	18	4	12	ns
^t PHL		000	5	18	5	14	
^t PHL	ACLR	Any Q	9	25	9	20	ns
^t PZH	ŌĒ	Any Q	6	23	6	18	ns
^t PZL	UE UE	Ally Q	6	29	6	24	113
^t PHZ	ŌĒ	Any Q	1	12	1	10	ns
^t PLZ		Any &	3	29	3	13	113

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_{\Gamma} = t_{f} = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



PACKAGE OPTION ADDENDUM



ti.com 6-Jun-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
83025022A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
8302502RA	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
8302502SA	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC
SN54ALS569AJ	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SN74ALS568AN	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74ALS569ADW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS569ADWE4	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS569ADWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS569ADWRE4	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS569AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS569ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS569ANSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS569ANSRE4	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS569AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54ALS569AJ	ACTIVE	CDIP	J	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54ALS569AW	ACTIVE	CFP	W	20	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.



PACKAGE OPTION ADDENDUM

6-Jun-2005

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by to Customer on an annual basis.

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within Mil-Std 1835 GDFP2-F20



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated